NST3904DP6T5G

Dual General Purpose Transistor

The NST3904DP6T5G device is a spin-off of our popular SOT-23/SOT-323/SOT-563 three-leaded device. It is designed for general purpose amplifier applications and is housed in the SOT-963 six-leaded surface mount package. By putting two discrete devices in one package, this device is ideal for low-power surface mount applications where board space is at a premium.

Features

- h_{FE}, 100-300
- Low $V_{CE(sat)}$, $\leq 0.4 V$
- Reduces Board Space and Component Count
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant

MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Collector – Emitter Voltage		V _{CEO}	40	Vdc
Collector - Base Voltage		V _{CBO}	60	Vdc
Emitter – Base Voltage		V _{EBO}	6.0	Vdc
Collector Current – Continuous		۱ _C	200	mAdc
Electrostatic Discharge	HBM MM	ESD Class	2 B	

THERMAL CHARACTERISTICS

Characteristic (Single Heated)	Symbol	Max	Unit
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 1)	P _D	240 1.9	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	R_{\thetaJA}	520	°C/W
Total Device Dissipation T _A = 25°C Derate above 25°C (Note 2)	P _D	280 2.2	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	446	°C/W
Characteristic (Dual Heated) (Note 3)	Symbol	Мах	Unit
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C (Note 1)	P _D	350 2.8	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 1)	$R_{\theta JA}$	357	°C/W
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above 25°C (Note 2)	P _D	420 3.4	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ hetaJA}$	297	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	– 55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

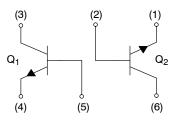
FR-4 @ 100 mm², 1 oz. copper traces, still air.
FR-4 @ 500 mm², 1 oz. copper traces, still air.

3. Dual heated values assume total power is sum of two equally powered channels.



ON Semiconductor®

www.onsemi.com



NST3904DP6T5G



SOT-963 CASE 527AD

MARKING DIAGRAM



= Device Code F Μ = Date Code

ORDERING INFORMATION

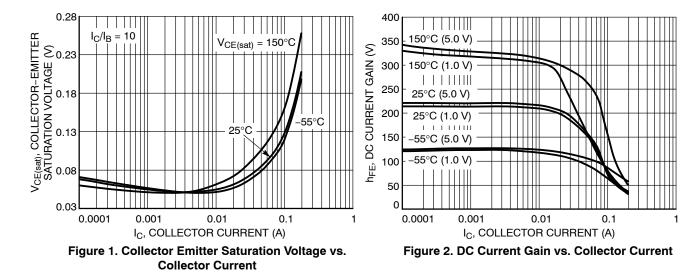
Device	Package	Shipping [†]
NST3904DP6T5G	SOT-963 (Pb-Free)	8000/Tape & Reel
NSVT3904DP6T5G	SOT-963 (Pb-Free)	8000/Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

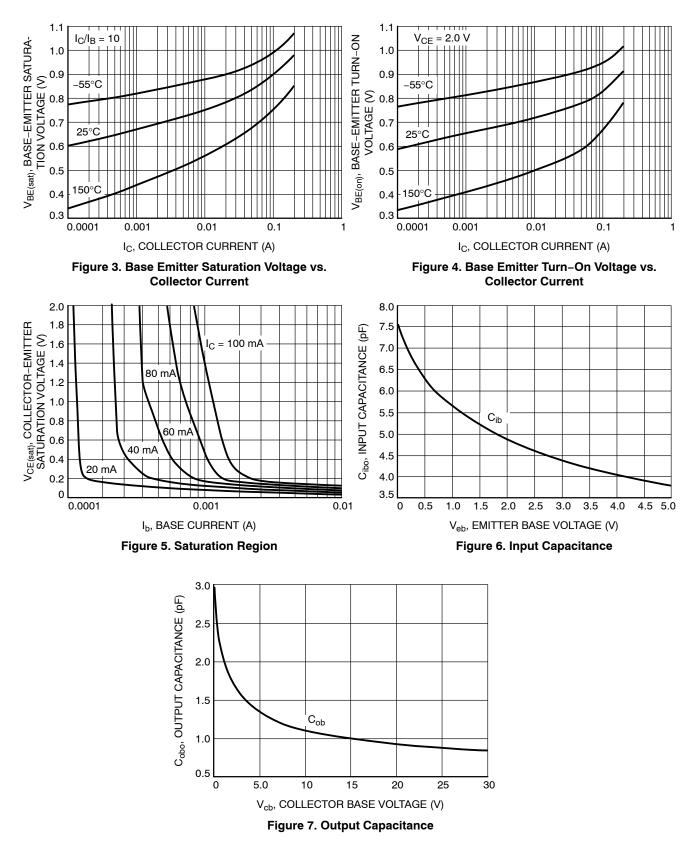
NST3904DP6T5G

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit	
OFF CHARACTERISTICS				•		
Collector – Emitter Breakdown Voltage (Note 4) ($I_C = 1.0 \text{ mAdc}, I_B = 0$)		V _{(BR)CEO}	40	-	Vdc	
Collector - Base Breakdown Volta	ge (I _C = 10 μAdc, I _E = 0)	V _{(BR)CBO}	60	-	Vdc	
Emitter – Base Breakdown Voltage	e (I _E = 10 μAdc, I _C = 0)	V _{(BR)EBO}	6.0	-	Vdc	
Collector Cutoff Current (V _{CE} = 3	I _{CEX}	-	50	nAdc		
ON CHARACTERISTICS (Note 4)		L			
$ \begin{array}{l} \text{DC Current Gain} \\ (I_{C}=0.1 \text{ mAdc}, V_{CE}=1.0 \text{ Vdc} \\ (I_{C}=1.0 \text{ mAdc}, V_{CE}=1.0 \text{ Vdc} \\ (I_{C}=10 \text{ mAdc}, V_{CE}=1.0 \text{ Vdc} \\ (I_{C}=50 \text{ mAdc}, V_{CE}=1.0 \text{ Vdc} \\ (I_{C}=100 \text{ mAdc}, V_{CE}=1.0 \text{ Vdc} \\ \end{array} $	5)))	h _{FE}	40 70 100 60 30	- - 300 - -	-	
		V _{CE(sat)}		0.2 0.3	Vdc	
Base – Emitter Saturation Voltage $(I_C = 10 \text{ mAdc}, I_B = 1.0 \text{ mAdc})$ $(I_C = 50 \text{ mAdc}, I_B = 5.0 \text{ mAdc})$		V _{BE(sat)}	0.65 -	0.85 0.95	Vdc	
SMALL-SIGNAL CHARACTERI	STICS		L			
Current – Gain – Bandwidth Product (I _C = 10 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)		f _T	200	-	MHz	
Output Capacitance (V_{CB} = 5.0 Vdc, I_E = 0, f = 1.0 MHz)		C _{obo}	_	4.0	pF	
Input Capacitance (V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MHz)		C _{ibo}	-	8.0	pF	
Noise Figure (V _{CE} = 5.0 Vdc, I _C = 100 μ Adc, R _S = 1.0 k Ω , f = 1.0 kHz)		NF	-	5.0	dB	
SWITCHING CHARACTERISTIC	S					
Delay Time	$(V_{CC} = 3.0 \text{ Vdc}, V_{BE} = -0.5 \text{ Vdc})$	t _d	-	35	ns	
Rise Time	(I _C = 10 mAdc, I _{B1} = 1.0 mAdc)	t _r	-	35		
Storage Time	(V _{CC} = 3.0 Vdc, I _C = 10 mAdc)	t _s	-	275	ns	
Fall Time	(I _{B1} = I _{B2} = 1.0 mAdc)	t _f	-	50		



NST3904DP6T5G



)nsem[[]

DATE 09 FEB 2010



SCALE 4:1

STYLE 1:

PIN 1. EMITTER 1

STYLE 4: PIN 1. COLLECTOR 2. COLLECTOR 3. BASE 4. EMITTER

STYLE 7: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE

5. ANODE 6. CATHODE

STYLE 10: PIN 1. CATHODE 1 2. N/C

5. N/C

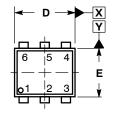
3. CATHODE 2 4. ANODE 2

6. ANODE 1

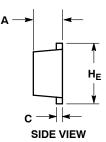
5. COLLECTOR 6. COLLECTOR

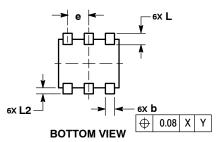
2. BASE 1 3. COLLECTOR 2 4. EMITTER 2

5. BASE 2 6. COLLECTOR 1



TOP VIEW





STYLE 2

PIN 1. EMITTER 1

STYLE 5: PIN 1. CATHODE 2. CATHODE 3. ANODE 4. ANODE

STYLE 8: PIN 1. DRAIN

5 DRAIN

2. DRAIN

6. DRAIN

3. GATE 4. SOURCE

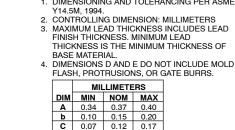
5. CATHODE 6. CATHODE

2. EMITTER2

3. BASE 2 4. COLLECTOR 2

5. BASE 1 6. COLLECTOR 1

SOT-963 CASE 527AD ISSUE E



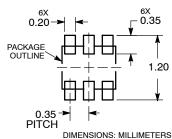
NOTES:

2. 3.

> A
> 0.34
> 0.37
> 0.40
>
>
> b
> 0.10
> 0.15
> 0.20
> С 0.07 0.12 0.17 0.951.001.050.750.800.85 D Е 0.35 BSC е ΗE 0.95 1.00 1.05 Т 0.19 REF L2 0.05 0.10 0.15

1. DIMENSIONING AND TOLERANCING PER ASME

RECOMMENDED **MOUNTING FOOTPRINT***



*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.



= Month Code М

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

DOCUMENT NUMBER:	98AON26456D	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOT-963, 1.00x1.00, 0.35P		PAGE 1 OF 1	
onsemi and ONSEMi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi ansemi and all liability.				

special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

STYLE 3

PIN 1. CATHODE 1 2. CATHODE 1

STYLE 6: PIN 1. CATHODE 2. ANODE 3. CATHODE 4. CATHODE 5. CATHODE 6. CATHODE

STYLE 9: PIN 1. SOURCE 1 2. GATE 1

3. DRAIN 2

5. GATE 2 6. DRAIN 1

4. SOURCE 2

3. ANODE/ANODE 2 4. CATHODE 2

5. CATHODE 2 6. ANODE/ANODE 1

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>